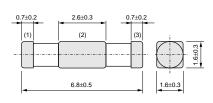
## **Data Sheet**

# Chip EMIFIL® LC Combined Type

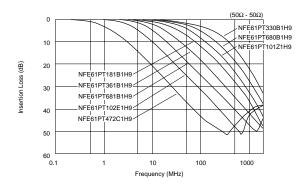
# NFE61P Series (2606 Size)

#### ■ Dimension

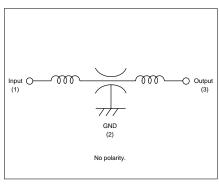


(in mm)

#### ■ IL of Main Items



# ■ Equivalent Circuit



## ■ Packaging

Code	Packaging	Minimum Quantity
L	180mm Plastic Tape	2500
K	330mm Plastic Tape	8000
В	Bulk(Bag)	500

## ■ Rated Value (□: packaging code)

Part Number	Capacitance	Rated Current	Rated Voltage	Insulation Resistance (min.)	Operating Temperature Range	Number of Circuit
NFE61PT330B1H9□	33pF+30%-30%	2A	50Vdc	1000M ohm	-25°C to +85°C	1
NFE61PT680B1H9□	68pF+30%-30%	2A	50Vdc	1000M ohm	-25°C to +85°C	1
NFE61PT101Z1H9□	100pF+30%-30%	2A	50Vdc	1000M ohm	-25°C to +85°C	1
NFE61PT181B1H9□	180pF+30%-30%	2A	50Vdc	1000M ohm	-25°C to +85°C	1
NFE61PT361B1H9□	360pF+20%-20%	2A	50Vdc	1000M ohm	-25°C to +85°C	1
NFE61PT681B1H9□	680pF+30%-30%	2A	50Vdc	1000M ohm	-25°C to +85°C	1
NFE61PT102E1H9□	1000pF+80%-20%	2A	50Vdc	1000M ohm	-25°C to +85°C	1
NFE61PT472C1H9□	4700pF+80%-20%	2A	50Vdc	1000M ohm	-25°C to +85°C	1

## ■ ①Caution/Notice

#### ⚠Caution (Rating)

Do not use products beyond the rated current and rated voltage as this may create excessive heat and deteriorate the insulation resistance.

#### Notice

Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use.

This data sheet is applied for CHIP EMIFIL® used for General Electronics equipment for your design.

	Noise Suppression Products/EMI Suppression Filters > Chip EMIFIL® LC Combined Type > T Type EM	
	Data Sheet	2
⚠ Note:		
1. Export Control		
	r sold for use in the development, production, stockpiling or utilization of any conventional weapons or mass-destructive	
weapons (nuclear weapons, chemica ⟨For customers in Japan⟩	or biological weapons, or missiles), or any other weapons.	
	s subject to the "Foreign Exchange and Foreign Trade Law" of Japan, the export license specified by the law is required	I
Please contact our sales representati especially high reliability for the preventance	res or product engineers before using the products in this data sheet for the applications listed below, which require nation of defects which might directly damage to a third party's life, body or property, or when one of our products is than those specified in this data sheet.	
Aircraft equipment	② Aerospace equipment	
<ul><li>③ Undersea equipment</li><li>⑤ Medical equipment</li></ul>	Power plant equipment Transportation equipment (vehicles, trains, ships, etc.)	
<ul><li>7 Traffic signal equipment</li><li>9 Data-processing equipment</li></ul>	Disaster prevention / crime prevention equipment Application of similar complexity and/or reliability requirements to the applications listed in the above	
They are subject to change or our probefore ordering. If there are any ques	ducts in it may be discontinued without advance notice. Please check with our sales representatives or product engineer ions, please contact our sales representatives or product engineers.	S

- This data sheet has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering. Especially, please read rating and  $\triangle$ CAUTION (for storage, operating, rating, soldering, mounting and handling) in them to prevent smoking and/or burning, etc.
- 5. You are able to read a detailed specification in the website of Search Engine (http://search.murata.co.jp/) or catalog library (http://www.murata.com/catalog/) before to require our product specification or to transact the approval sheet for product specification.
- 6. Please note that unless otherwise specified, we shall assume no responsibility whatsoever for any conflict or dispute that may occur in connection with the effect of our and/or a third party's intellectual property rights and other related rights in consideration of your use of our products and/or information described or contained in our data sheets. In this connection, no representation shall be made to the effect that any third parties are authorized to use the right mentioned above under licenses without our consent.
- 7. No ozone depleting substances (ODS) under the Montreal Protocol are used in our manufacturing process.
  - This data sheet is applied for CHIP EMIFIL<sup>®</sup> used for General Electronics equipment for your design.